SWITCHMODE[™] Power Rectifier

Features and Benefits

- Center–Tap Configuration
- Low Forward Voltage
- Low Power Loss / High Efficiency
- High Surge Capacity
- 175°C Operating Junction Temperature
- 15 A Total (7.5 A Per Diode Leg)
- Pb-Free Package is Available*

Applications

- Power Supply Output Rectification
- Power Management
- Instrumentation

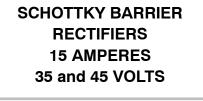
Mechanical Characteristics

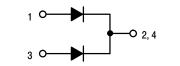
- Case: Epoxy, Molded
- Epoxy Meets UL 94, V-0 @ 0.125 in
- Weight: 1.9 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- ESD Rating: Human Body Model = 3B Machine Model = C



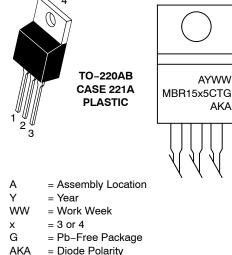
ON Semiconductor®

http://onsemi.com









ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MBR1535CT MBR1545CT	V _{RRM} V _{RWM} V _R	35	V
Average Rectified Forward Current	I _{F(AV)}	45	A
(T _C = 163°C) Per Diode Per Device		7.5 15	
Peak Repetitive Forward Current (Square Wave, 20 kHz, T _C = 161°C) Per Diode	I _{FRM}	15	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	150	A
Peak Repetitive Reverse Surge Current (2.0 µs, 1.0 kHz)	I _{RRM}	1.0	А
Storage Temperature Range	T _{stg}	-65 to +175	°C
Operating Junction Temperature (Note 1)	TJ	-65 to +175	°C
Voltage Rate of Change (Rated V _R)	dv/dt	1000	V/μs

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. The heat generated must be less than the thermal conductivity from Junction-to-Ambient: $dP_D/dT_J < 1/R_{\theta JA}$.

THERMAL CHARACTERISTICS PER DIODE

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance, Junction-to-Case (Min. Pad)	$R_{\theta JC}$	3.0	°C/W
Maximum Thermal Resistance, Junction-to-Ambient (Min. Pad)	$R_{\theta JA}$	60	°C/W

ELECTRICAL CHARACTERISTICS PER DIODE

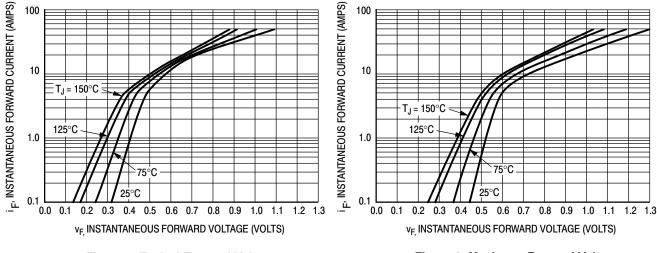
Characteristic	Symbol	Min	Тур	Max	Unit
Maximum Instantaneous Forward Voltage (Note 2) ($i_F = 7.5 \text{ Amps}, T_J = 125^{\circ}\text{C}$) ($i_F = 15 \text{ Amps}, T_J = 125^{\circ}\text{C}$) ($i_F = 15 \text{ Amps}, T_J = 25^{\circ}\text{C}$)	٧F		0.47 0.63 0.66	0.57 0.72 0.84	V
Maximum Instantaneous Reverse Current (Note 2) (Rated DC Voltage, $T_J = 125^{\circ}C$) (Rated DC Voltage, $T_J = 25^{\circ}C$)	İR	-	10 0.025	15 0.1	mA

2. Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%

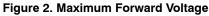
ORDERING INFORMATION

Device	Package	Shipping [†]
MBR1535CT	TO-220	50 Units / Rail
MBR1535CTG	TO-220 (Pb-Free)	50 Units / Rail
MBR1545CT	TO-220	50 Units / Rail
MBR1545CTG	TO-220 (Pb-Free)	50 Units / Rail

⁺For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.







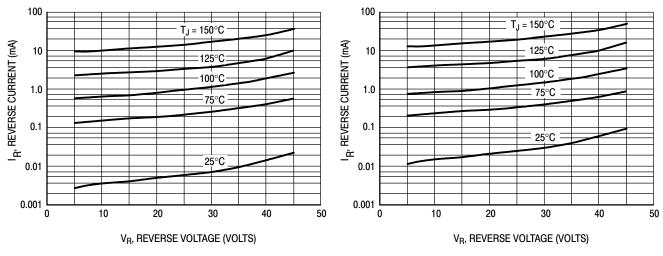


Figure 3. Typical Reverse Current



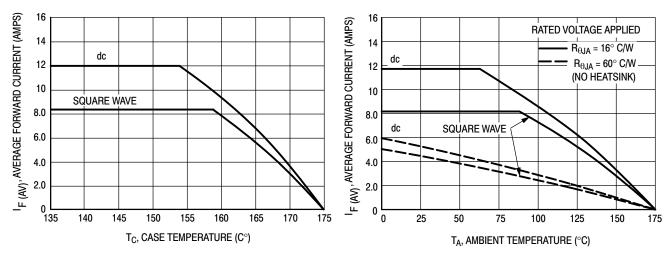
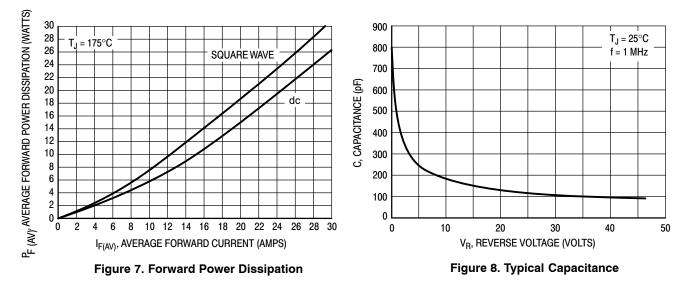


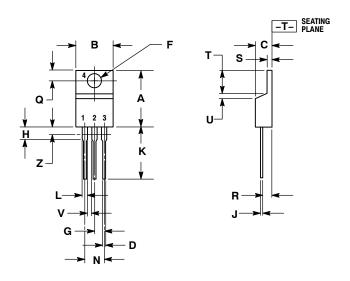


Figure 6. Current Derating, Ambient Per Leg



PACKAGE DIMENSIONS

TO-220 CASE 221A-09 ISSUE AF



	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN MA		
Α	0.570	0.620	14.48	15.75	
В	0.380	0.405	9.66	10.28	
С	0.160	0.190	4.07	4.82	
D	0.025	0.035	0.64	0.88	
F	0.142	0.161	3.61	4.09	
G	0.095	0.105	2.42	2.66	
Н	0.110	0.155	2.80	3.93	
J	0.014	0.025	0.36	0.64	
Κ	0.500	0.562	12.70	14.27	
L	0.045	0.060	1.15	1.52	
Ν	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.39	
Т	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
۷	0.045		1.15		
Ζ		0.080		2.04	
PIN	1. ANO	HODE			

DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.

DIMENSION Z DEFINES A ZONE WHERE ALL

NOTES:

1.

2

3.

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